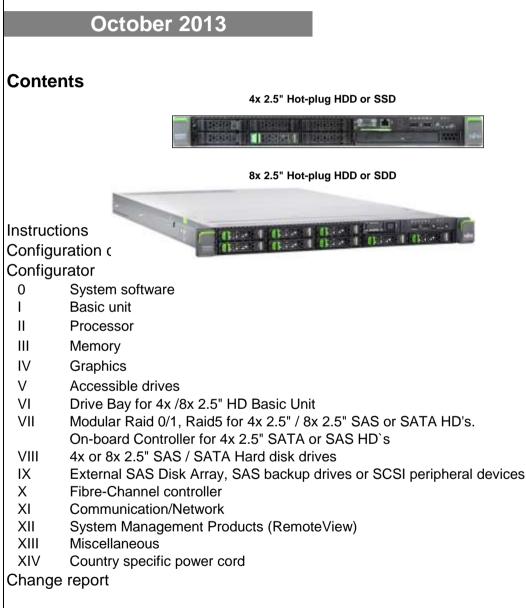


PRIMERGY RX200 S7

System configurator and order-information guide



PRIMERGY Server

Instructions

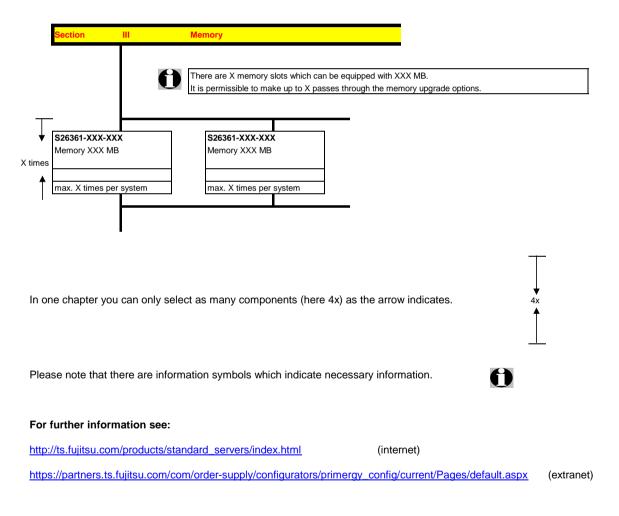
This document contains basic product and configuration information that will enable you to configure your system via PC-/SystemArchitect.

Only these tools will ensure a fast and proper configuration of your PRIMERGY server or your complete PRIMERGY Rack system.

You can configure your individual PRIMERGY server in order to adjust your specific requirements.

The System configurator is divided into several chapters that are identical to the current price list and PC-/SystemArchitect.

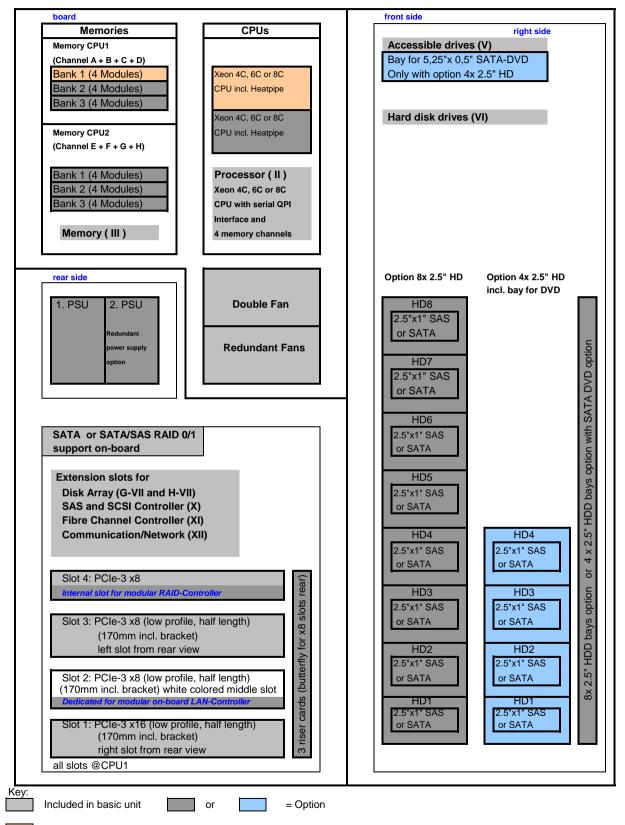
Please follow the lines. If there is a junction, you can choose which way or component you would like to take. Go through the configurator by following the lines from the top to the bottom.



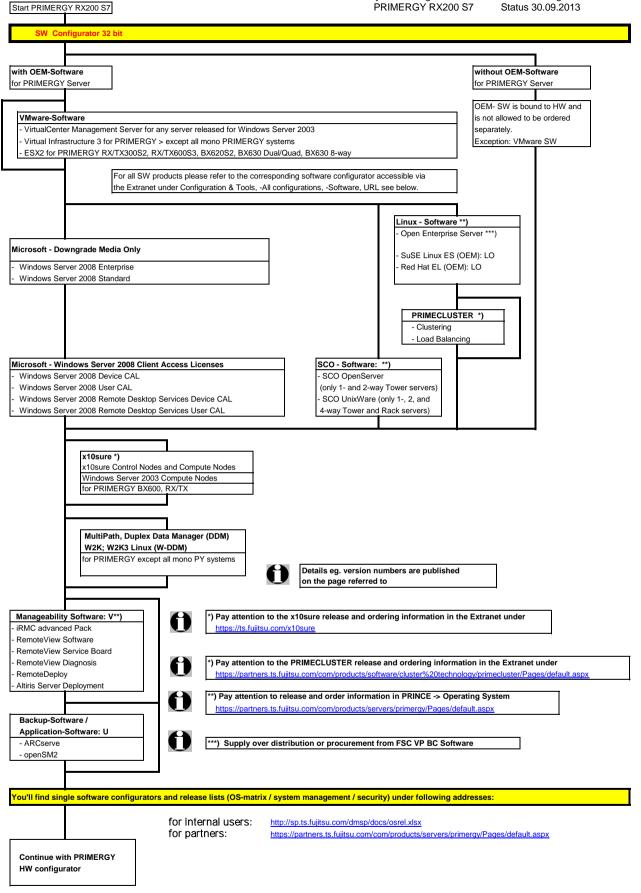
Prices and availability see price list and PC-/SystemArchitect. Subject to change and errors excepted.

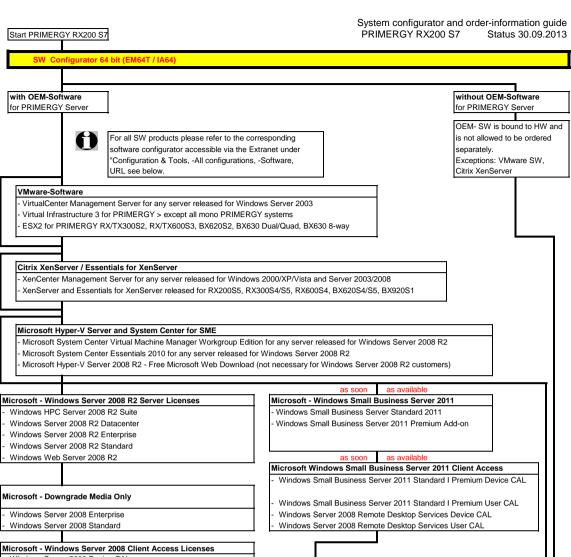
Configuration diagram PRIMERGY RX200 S7

System unit (I)



One CPU (first CPU) and one memory (first memory) has to be selected for an orderable basic unit.

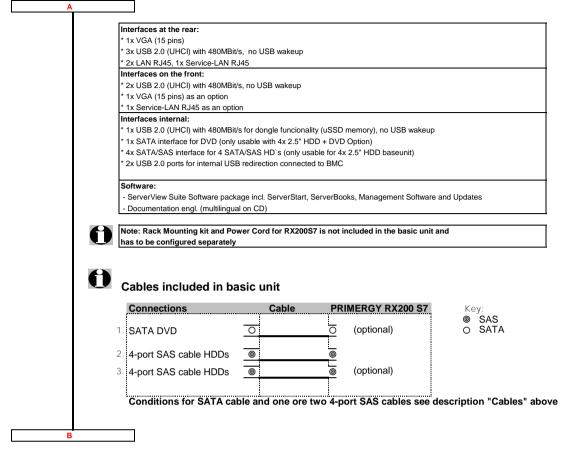


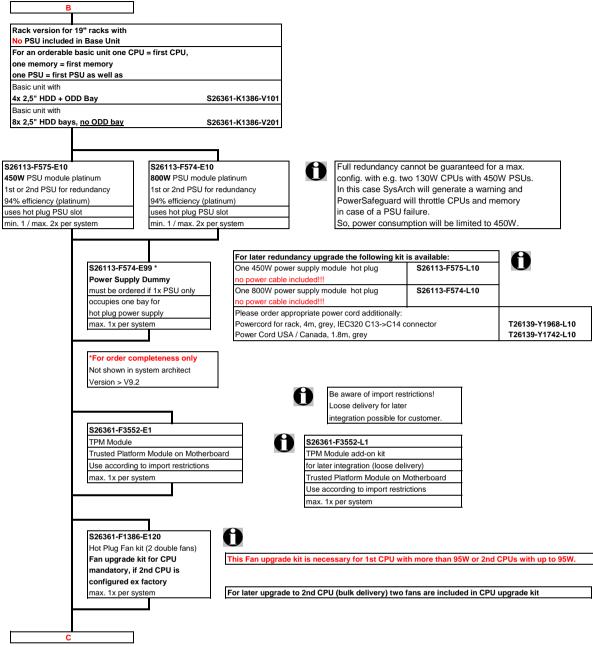


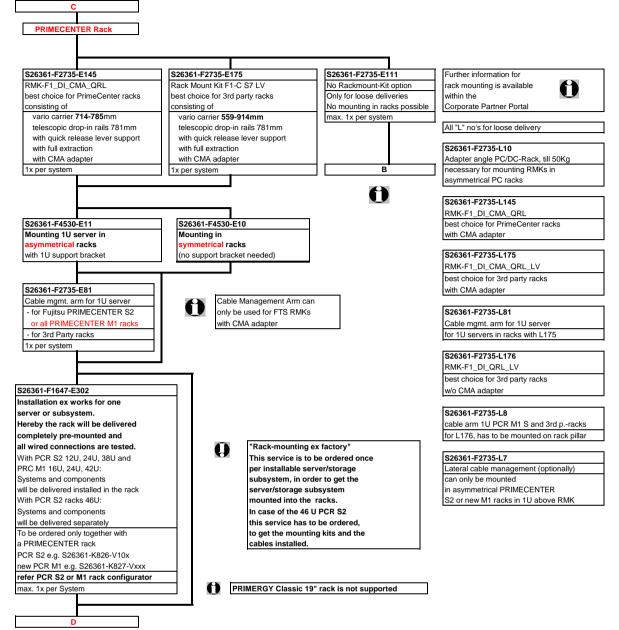
with OFM-Software

- Microsoft Windows Server 2008 Client Access Licenses Windows Server 2008 Device CAL Windows Server 2008 User CAL Windows Server 2008 Remote Desktop Services Device CAL Linux - Software *) **) Windows Server 2008 Remote Desktop Services User CAL # Open Enterprise Server - SuSE Linux ES (OEM): LO only EM64T - Red Hat EL (OEM): LO PRIMECLUSTER *) Clustering Load Balancing QuickTransit (QT) only Transition Solaris Apps. EM64T to x86-64 PY with Linux MultiPath, Duplex Data only Details eg. version numbers are published EM64T Manager (DDM) on the page referred to Windows, Linux (W-DDM) *) Pay attention to the PRIMECLUSTER release and ordering information in the Extranet under partners.ts.fuiitsu.com/com/products/software/cluster%20technolo Manageability Software: V**) *) Pay attention to release and order information in PRINCE -> Operating System iRMC advanced Pack only RemoteView Software //partners.ts.fujitsu.com/com/products/servers/primergy/Pages/default.a FM64T RemoteView Service Board RemoteView Diagnosis ***) Supply over distribution or procurement from FSC VP BC Software RemoteDeploy You'll find single software configurators and release lists (OS-matrix / system management / security) under following addresses: for internal users: http://sp.ts.fujitsu.com/dmsp/docs/osrel.xlsx Continue with PRIMERGY for partners: https://partners.ts.fujitsu.com/com/products/servers/primergy/Pages/default.aspx HW configurator

n I	Basic unit
	System unit consisting of:
	* 10 Housing without power supply modules
	(PSU has to be configured min 1x)
	* Fans
	- Redundant and hot plug system double-fans 4x for 1 CPU / 6x for 2 CPU configuration (n+1 redundancy)
	* SAS Backplanes for 4x or 8x 2.5" HDD
	with cable connection to on-board or modular RAID Controller
	* Drives / Bays
	- 4x 2.5" SAS / SATA HDD or 8x 2.5" SAS / SATA HDD option
	- 1 bay SATA DVD-ROM 0,5" height (option if 4x 2.5" HDD only)
	* Integrated ServerView Diagnostics Technology (Diagnosis LED's) for indication of internal failed components
	Systemboard D3032 with:
	* Up to two Xeon 4C, 6C & 8C CPU's (Socket-R)
	with 2 serial QPI links (Quick Path Interconnect) and four memory channels per CPU
	First CPU has to be selected for an orderable basic unit,
	* Chipset Intel® C600 Series (codenamed Patsburg)
	* 4 PCIe slots
	-2x PCIe-3 x8 (Low Profile cards)
	-1x PCIe-3 x16 (Low Profile cards) -1x PCIe-3 x8 internal for modular RAID controller only
	* 24 memory slots for max. 768GB RAM DDR3 available
	- Memory is divided into 12 DIMMs per CPU (4 channels with 3 slots per channel)
	Possible max. configurations are:
	24x 32GB LRDIMM (quad rank modules) = 768GB
	16x 16GB RDIMM quad rank modules) = 384GB
	16x 4GB UDIMM (dual rank modules) = 64GB
	First Memory (one module) has to be selected for an orderable basic unit per CPU
	- Memory upgrade is possible module wise Memory minutes in summated with 9 identical modules in shared A.B. CBU 4 or D.E. CBU 2
	 Memory mirrroring is supported with 2 identical modules in channel A+B CPU 1 or D+E CPU 2 Hot Spare Memory is supported with 3 identical modules in channel A+B+C CPU 1 or D+E+F CPU 2
	- Rot spare memory is supported with 3 identical modules in chamer A+B+C CPO 1 of B+E+P CPO 2 - SDDC (Chipkill) is supported for memory modules,
	* Dual Port 10/100/1000 x4 PCI Express* Gigabit Ethernet Intel LAN controller Powerville on-board
	* iRMC S3 (integrated Remote Management Controller) on-board server management controller with
	dedicated 10/100/1000 Service LAN-port and integrated graphics controller.
	The Service LAN-port can be switched alternatively on standard Gbit LAN port 1
	* Graphics Controller integrated in iRMC S3 (integrated Remote Management Controller):
	1600x1200x16bpp 60Hz, 1280x1024x16bpp 60Hz, 1024x768x32bpp 75Hz, 800x600x32bpp 85Hz, 640x480x32bpp 85Hz
	(1280x1024x24bpp 60Hz only possible if local monitor or remote video redirection is off)







There are 2 processor sockets available.		
The first socket is always equipped with the f		-
It is also possible to upgrade a dual-processo		
For the configuration of the 2nd CPU ex factor		-
Two processors with different clock frequ	•	
A multi-processor operating system is require	ed for a dual-processor	system.
Max. two CPU`s can be selected per basic unit		Note: Max. DDR3 Bus Speed depends on:
One of following CPU's has to be selected as first CPU		- max. DDR3 Bus Speed from the CPU and
for an orderable basic unit		- max. DDR3 Memory Speed and
Optional second CPU has to be the same type like the first CPU		- max. memory modules on one memory channe
Basic 4C CPU's		1
- 1x 64-bit Intel Xeon (10MB Smart Cache)		
1066 MHz DDR3 Bus; 6,40 GT/s QPI Bus and passive heat sink		
occupies socket for one CPU		
Xeon E5-2603 4C/4T 1.80GHz 10MB 6.40GT/s 1066MHz 80W	S26361-F3689-E180	
Xeon E5-2609 4C/4T 2.40GHz 10MB 6.40GT/s 1066MHz 80W	S26361-F3689-E240	
Standard Turbo 6C CPU's		1
- 1x 64-bit Intel Xeon (15MB Smart Cache); Hyper-Threading (HT);		
1333 MHz DDR3 Bus; 7,20 GT/s QPI Bus and passive heat sink		
occupies socket for one CPU		
Xeon E5-2620 6C/12T 2.00GHz 15MB 7.20GT/s 1333MHz 95W	S26361-F3690-E200	4
Xeon E5-2630 6C/12T 2.30GHz 15MB 7.20GT/s 1333MHz 95W	S26361-F3690-E230	
Xeon E5-2640 6C/12T 2.50GHz 15MB 7.20GT/s 1333MHz 95W	S26361-F3690-E250	
Advanced Turbo+ 8C CPU's		
- 1x 64-bit Intel Xeon (20MB Smart Cache); Hyper-Threading (HT);		
1600 MHz DDR3 Bus; 8,00 GT/s QPI Bus and passive heat sink		
occupies socket for one CPU	000004 50004 5000	4
Xeon E5-2650 8C/16T 2.00GHz 20MB 8.00GT/s 1600MHz 95W	S26361-F3691-E200	4
Xeon E5-2660 8C/16T 2.20GHz 20MB 8.00GT/s 1600MHz 95W Xeon E5-2665 8C/16T 2.40GHz 20MB 8.00GT/s 1600MHz 115W	S26361-F3691-E220 S26361-F3691-E240	On special release only
Xeon E5-2670 8C/16T 2.60GHz 20MB 8.00GT/s 1600MHz 115W	S26361-F3691-E260	
Xeon E5-2680 8C/16T 2.70GHz 20MB 8.00GT/s 1600MHz 113W	S26361-F3691-E270	
Xeon E5-2690 8C/16T 2.90GHz 20MB 8.00GT/s 1600MHz 135W	S26361-F3691-E290	
Frequency Optimized Turbo 2C, 4C & 6C CPU's		and 10k SAS HDDs
- 1x 64-bit Intel Xeon (5/10/15MB Smart Cache); Hyper-Threading (HT);		
1600 MHz DDR3 Bus; 6,40/7,20 GT/s QPI Bus and passive heat sink		
occupies socket for one CPU		
Xeon E5-2637 2C/4T 3.00GHz 5MB 6.40GT/s 1600MHz 80W	S26361-F3692-E300	1
Xeon E5-2643 4C/8T 3.3GHz 10MB 6.40GT/s 1600MHz 130W	S26361-F3692-E330	
Xeon E5-2667 6C/12T 2.90GHz 15MB 7.20GT/s 1600MHz 130W	S26361-F3692-E290	1
Low Power 4C/6C/8C CPU's		I construction of the second se
- 1x 64-bit Intel Xeon (15/20MB Smart Cache); Hyper-Threading (HT);		
1333/1600 MHz DDR3 Bus; 7,20/8,00 GT/s QPI Bus and passive heat sink		
		1
occupies socket for one CPU		
occupies socket for one CPU Xeon E5-2630L 6C/12T 2.00GHz 15MB 7.20GT/s 1333MHz 60W Xeon E5-2650L 8C/16T 1.80GHz 20MB 8.00GT/s 1600MHz 70W	S26361-F3693-E200 S26361-F3693-E180	

tion	III Memory
	- There are 12 memory slots per CPU for max.
	384GB LRDIMM (12x 32GB 4R) 192GB RDIMM (12x 16GB 2R)
	32GB UDIMM (8x 4GB)
	=> max. 768GB for two CPU's (384GB per CPU), using LRDIMM
	- The memory area is divided into 4 channels per CPU with 3 slots per channel
	- Slot 1 of each channel belongs to memory bank 1, the slot 2 belongs to memory bank 2,
	slot 3 belongs to memory bank 3
	Registered, LR DIMMs and unbuffered memory modules can be selected
	No mix of registered, load reduced and unbuffered modules allowed.
	Memory can be operated at 1.5V or 1.35V, even if the modules are of low voltage type.
	Memory operating voltage can be set within BIOS (1.5V is default setting for max. speed).
	In a 2 DIMMs per channel configuration, following frequencies are supported: - 1.5V - 1600MHz max (depending on CPU, special memory modules)
	- 1.35V - 1333MHz max (depending on CPU)
	In a 3 DIMMs per channel configuration, memory will operate at 1.5V only.
	SDDC (Chipkill) is supported for registered / load redueced x4 organized memory modules only
	1.) In the "Independent Channel Mode" is following configuration possible
	Channels can be populated in any order in Independent Channel Mode. All four
	channels may be populated in any order and have no matching requirements. All
	channels must run at the same interface frequency but individual channels may run at
	different DIMM timings (RAS latency, CAS latency, and so forth)
	No mix of registered, load reduced and unbuffered modules allowed.
	2.) "Rank Sparing Mode" configuration
	- Within a memory channel, one rank is a spare of the other ranks.
	The Spare Rank is held in reserve and is not available as system memory
	For the effective memory capacity, please refer to the spreadsheet below. The BIOS is set to the rank sparing setting.
	Minimum configuration is: 2x 1R, 2x 2R or 1x4R DDR3 module per channel
	This mode is not supported by unbuffered memory modules
	2) "Borformance Mode" configuration
	 3.) "Performance Mode" configuration - In this configuration, the memory module population ex factory is spread across all channels.
	The BIOS is set to the max. performance for memory.
	Minimum configuration is: 4x identical modules
	4) In the "Missered Chennel Mede" is following configuration possible
	 4.) In the "Mirrored Channel Mode" is following configuration possible Each memory bank can optionally be equipped with 4x registered or load reduced or unbuffered DDR3 modules
	In each memory bank channel A and B / C and D of CPU 1 or channel E and F / G and H of CPU 2 have to be
	equipped with identical modules for mirrored channel mode.
	In channel B / D is always the mirrored memory of channel A / B of CPU 1
	In channel F / H is always the mirrored memory of channel E / G of CPU 2
	Minimum configuration is: 4x identical modules This mode is not supported by unbuffered memory modules
	S26361-F3694-E10 Independent Mode
	Independent Channel Mode allows all channels to be populated in any order. No specific Memory RAS features are defined Requires min 1 memory Module per CPU
	S26361-F3694-E1 Rank Sparing Mode Installation
	BIOS Setup factory preinstalled to this mode. One Rank is spare of other ranks on the same channel. Spare Rank is not shown in System Memory.
	For effective capacity within a channel, please have a look below.
,	Supported for RDIMM / LRDIMM only.
CPU	Requires min 2x 1R/2R or 1x 4R modules per CPU
	S26361-F3694-E2 Performance Mode Installation PIOS Sature feature projectelled for max. Performance, I/V memory might be set to 1.5V exercises. Four identical memory medules.
	BIOS Setup factory preinstalled for max. Performance, LV memory might be set to 1.5V operation. Four identical memory modules will be equipped in one memory bank to achieve highest memory performance. All four modules are active and full capacity can be used.
	Multiple of 4 identical modules to be configured per CPU
	S26361-F3694-E3 Mirrored Channel Mode Installation
	BIOS Setup factory preinstalled to this mode. Four identical memory modules are always equipped in one memory bank to use the
	Mirrored channel Mode. Only two modules contain active data, the remain two modules contain mirrored data
	Supported for RDIMM / LRDIMM only.
	Multiple of 4 identical modules to be configured per CPU

E

Effective Memory capacity / Rank Sparing Mode, 1 Channel populated

	UDIMM		RDIMM			LRDIMM	
	2 1F	2 2 R	4 1R	8 2R	16 2R	16 4R	32 4R
1	na	na	na	na	na	12	24
2	na	na	4	12	24	28	56
3	na	na	8	20	40	40	80

Minimum one memory module or order code per CPU = first memory

Choose up to 8 order codes per CPU 2GB (1x2GB) 1Rx8 L DDR3-1600 U ECC 4GB (1x4GB) 2Rx8 L DDR3-1600 U ECC Registered Memory (RDIMM) no SDDC (chipkill) support one DDR3 registered ECC mem. Module, 1.35V No mix with any other types of memory modules possible Choose up to 12x for 1R/2R or 8x for 4R per CPU For performance reasons, we do not recommend to configure more than 8 DIMMs per CPU 4GB (1x4GB) 2Rx8 L DDR3-1600 R ECC Registered Memory (RDIMM) with SDDC (chipkill) support 8/12x per one DDR3 registered ECC mem. Module, 1.35V CPU, max. 1333MHz supported with up to 2DPC (8 modules/CPU) 2/3 modules Choose up to 12 order codes per CPU per channel 4GB (1x4GB) 1Rx4 L DDR3-1333 R ECC 8GB (1x8GB) 2Rx4 L DDR3-1333 R ECC Registered Memory (RDIMM) with SDDC (chipkill) support one DDR3 registered ECC mem. Module, 1.35V 1600MHz supported with up to 2DPC (8 modules/CPU) at 1.5V Choose up to 12 order codes per CPU 4GB (1x4GB) 1Rx4 L DDR3-1600 R ECC

G

Note 1.)

Unbuffered Memory (UDIMM) no SDDC (chipkill) support Max. DDR3 memory speed depends on the memory configuration one DDR3 unbuffered ECC mem. Module, 1.35V (No of mem modules per channe) as well as on the CPU type. The memory channel with the lowest speed defines the speed S26361-F3694-E513 of all CPU channels in the system, also for the channels of the S26361-F3694-E514 second CPU if configured For real memory speed (depending on memory type / population), please check the spreadsheet "Memory speed" below S26361-F3695-E514 A Mix of memory modules is only possible within the same group S26361-F3696-E514 new due to supply S26361-F3696-E515 new due to supply S26361-F3697-E514 8GB (1x8GB) 2Rx4 L DDR3-1600 R ECC S26361-F3697-E515 16GB (1x16GB) 2Rx4 L DDR3-1600 R ECC S26361-F3697-E516 Load Reduced Memory (LRDIMM) with SDDC (chipkill) support one DDR3 load reduced ECC mem. Module, 1,35V Choose up to 12 order codes per CPU 16GB (1x16GB) 4Rx4 L DDR3-1333 LR ECC S26361-F3698-E516 extended delivery time 32GB (1x32GB) 4Rx4 L DDR3-1333 LR ECC S26361-F3698-E517 extended delivery time

Memory Configuration PRIMERGY RX200 S7

Each CPU offers 12 Slots for DDR3 Memory Modules organised in 3 Banks and 4 Channels. If you need more than 12 Slots you have to configure the 2nd CPU. Depending on the amount of memory configured you can decide between 4 basic modes of operation (see explanation below).

There are 3 different kinds of DDR3 Memory Modules available: UDIMM / RDIMM and LRDIMM UDIMM / RDIMM / LRDIMM offer different functionality. Mix of UDIMM / RDIMM / LRDIMM is not alloved.

If 1.5V and 1.35V DIMMs are mixed, the DIMMs will run at 1.5V

Mode	Configuration	1		RDIMM	Application
		UDIMM	RDIMM	LRDIMM	
		x8	x8	x4	
SDDC (chipkill) support	any	no	no	yes	detect multi-bit errors
Independant Channel Mode	1, 2 or 3 Modules per Bank	yes	yes	yes	offers max. flexibility, upgradeability, capacity use UDIMM modules for lowest cost
Mirrored Channel Mode *)	4 identical Modules / Bank	no	no	yes	offers maximum security
Performance Mode	4 identical Modules / Bank	yes	yes	yes	offers maximum performance and capacity
Rank Sparing Mode *)	min. 2 Ranks / Channel	no	no	yes	balances security and capacity

For the delivery ex works the system will be prepared with dedicated BIOS setting.

on special release

as soon as available

Capacity	Configuration	UDIMM	RDIMM	LRDIMM	Notes
Min. Memory per CPU	1 Module / CPU	1x2GB	1x4GB	1x 16GB	with one CPU
Max. Memory per CPU	8/12 Modules / CPU	8x4GB	12x16GB	12x 32GB	with one CPU
Max. Memory per System	16/24 Modules / System	64GB	384GB	768GB	if second CPU is configured

Memory-Speed:

Max. DDR3 memory speed depends on the memory configuration on one memory channel and the speed of the CPU The memory channel with the lowest speed defines the speed of all CPU channels in the system

Mem. Speed provided by CPU	ory-bus	s speed	d depei	nding o	n CPU	type, n	nemory	/ config	uratior	(DPC) and v	oltage	setting	(BIOS)				
	UDIN	IM 16	00MH	łz			RDIN	ИМ 16	500MI	Ηz			LRD	IMM [·]	1333N	ЛНz		
Voltage setting (BIOS)	1.5V	[defai	ult]	1.35	V		1.5V	[defa	ult]	1.35	V		1.5V	' [defa	ault]	1.35	V	
	1	2	3	1	2	3	1	2	3	1	2	3	1	2	3	1	2	3
	DPC	DPC	DPC	DPC	DPC	DPC	DPC	DPC	DPC	DPC	DPC	DPC	DPC	DPC	DPC	DPC	DPC	DPC
	1333		-	1066		-						-						
CPU with 1600MHz DDR3 Bus	1600	1333	-	1333	1066	-	1600	1600	1066	1333	1333	-				1066	1066	1066
CPU with 1333MHz DDR3 Bus	1333	1333	-	1066	1066	-	1333	1333	1066	1333	1333	-	I			1066	1066	1066
CPU with 1066MHz DDR3 Bus	1066	1066		1066	1066	-	1066	1066	1066	1066	1066	-	not su	pporte	d	1066	1066	1066

1R - Single Rank

2R - Dual Rank

4R - Quad Rank

1DPC = 1 DIMM per Channel 2DPC = 2 DIMM per Channel 3DPC = 3 DIMM per Channel

Configuration hints:

- The memory sockets on the systemboard offer a color coding:

- black sockets Bank I Bank II
- blue sockets Bank III green sockets

- A so called Bank consits of 1 memory module on every Channel available on one CPU (examples see below) Bank I on CPU 1/2 Bank II on CPU 1/2 Bank III on CPU 1/2

up to 4 memory modules connected to Channel A - H on the 1st/2nd CPU

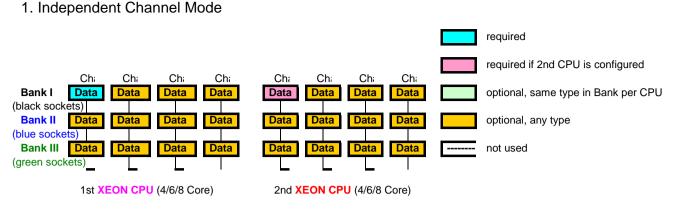
up to 4 memory modules connected to Channel A - E on the 1st/2nd CPU

up to 4 memory modules connected to Channel A - E on the 1st/2nd CPU

(can not be populated by UDIMM or 4R RDIMM memory modules)

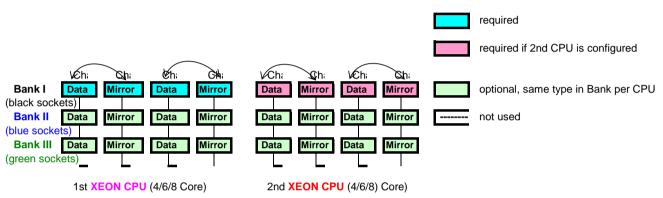
- See below and next page for a detailed descriptions of the memory configuration supported.

System configurator and order-information guide PRIMERGY RX200 S7 Status 30.09.2013



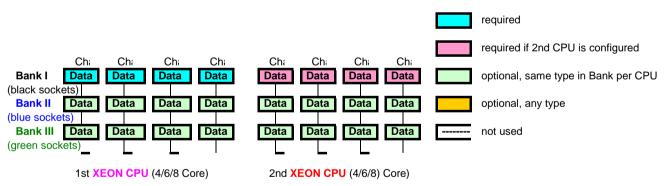
Independent Channel Mode allows all channels to be populated in any order Can run with differently rated DIMMs and use the settings of the slowest DIMM installed in the system

2. Mirrored Channel Mode



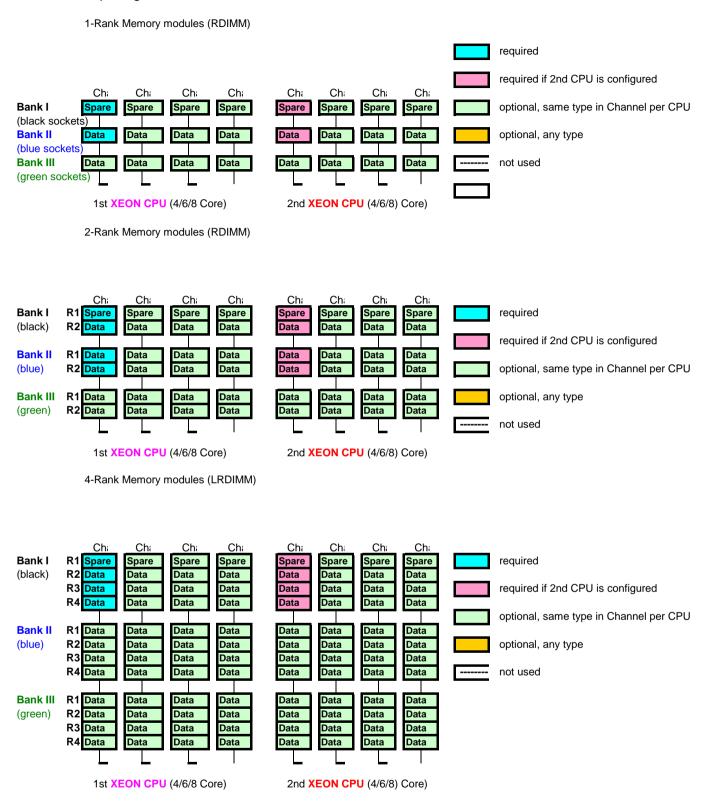
Mirrored Channel Mode requires identical modules on channel A,B, C, D (1st CPU) or channel E, F, G and H (2nd CPU) 50% of the capacity is used for the mirror => the available memory for applications is only half of the installed memory If this mode is used, a multiple of 4 identical modules has to be ordered.

3. Performance Channel Mode

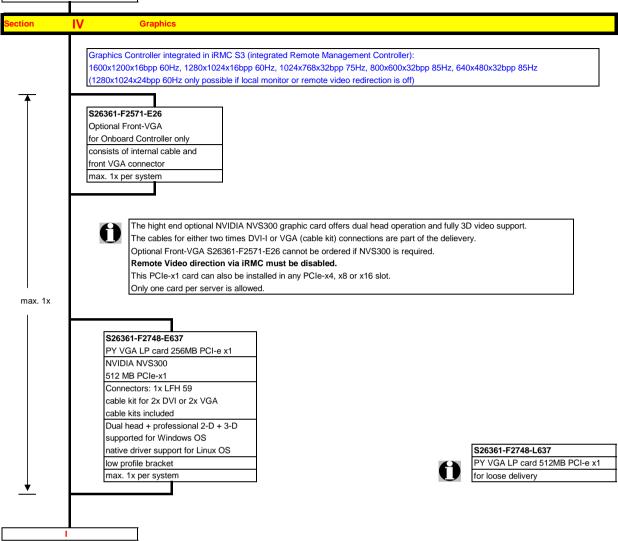


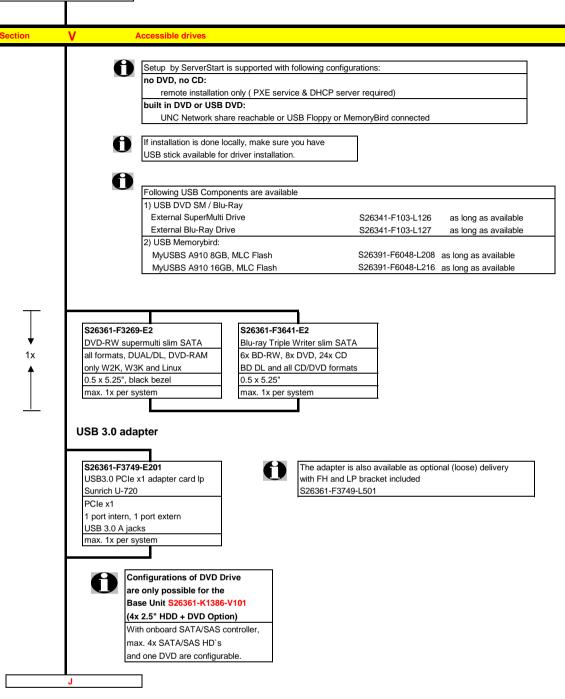
Performance Channel Mode requires identical modules on all channels of each Bank per CPU. If this mode is used, a multiple of 4 identical modules has to be ordered.

4. Rank Sparing Mode

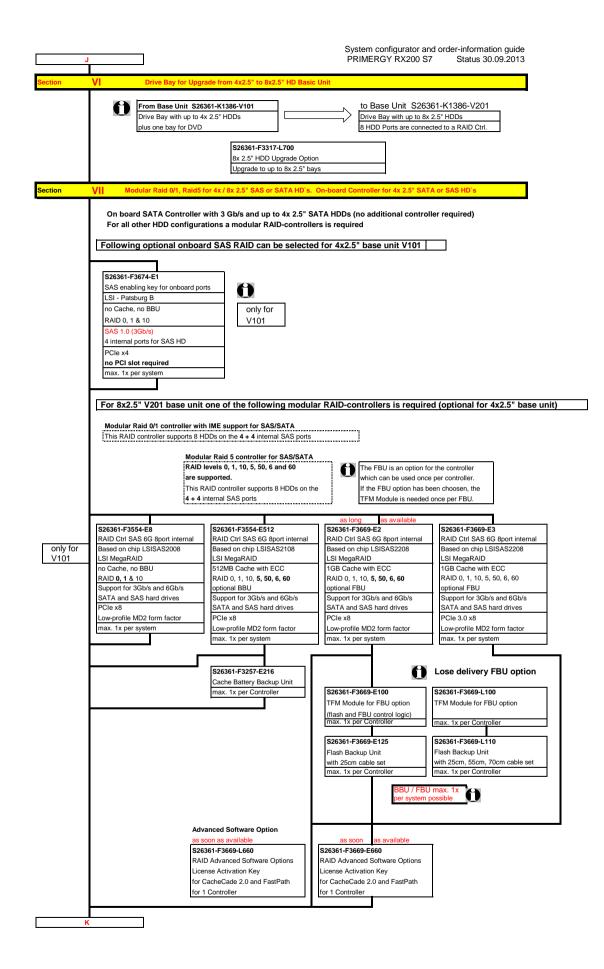


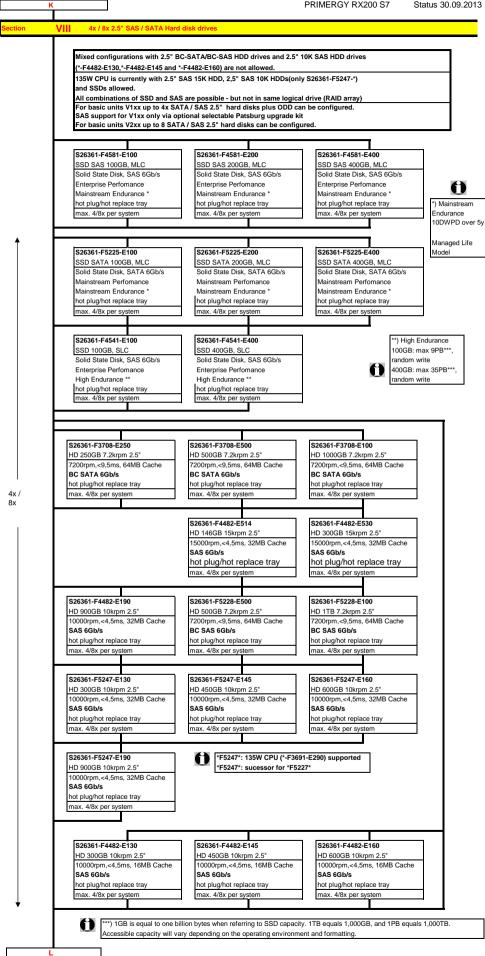
Rank Sparing Mode requires identical modules (same capacity and technology) within the same channel. The available memory for applications will vary depending on configuration. Please refer to the spreadsheet above "Effective Memory capacity with active Rank Sparing Mode". Population rule for Rank sparing mode is to achieve max. available memory, e.g. 6 DIMMs will be spread across two channels, each with 3DPC

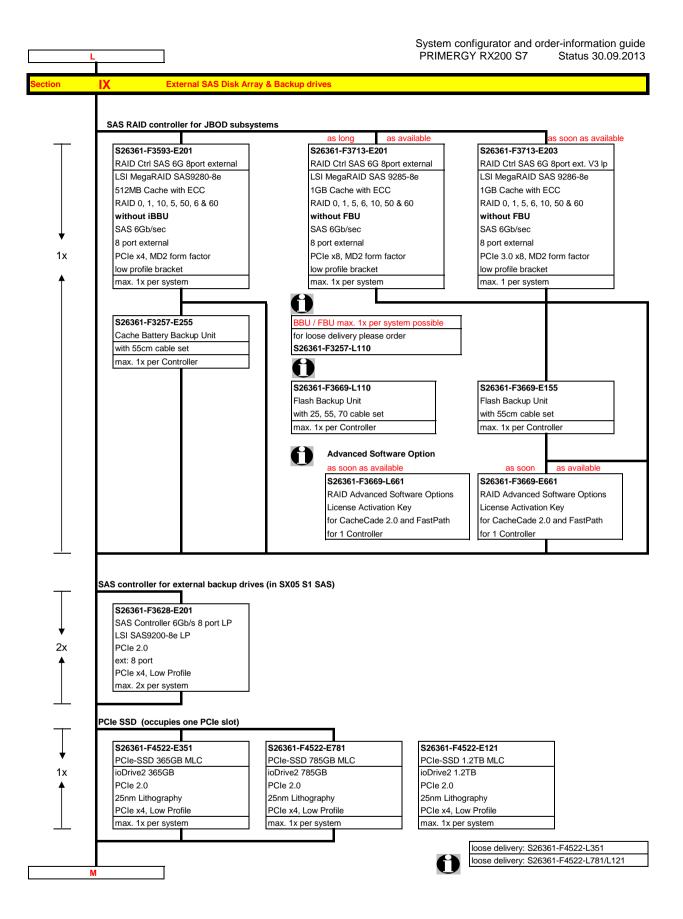


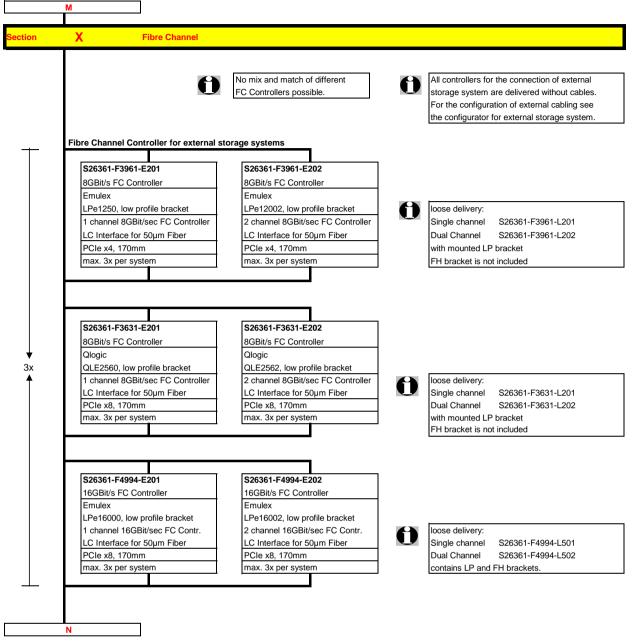


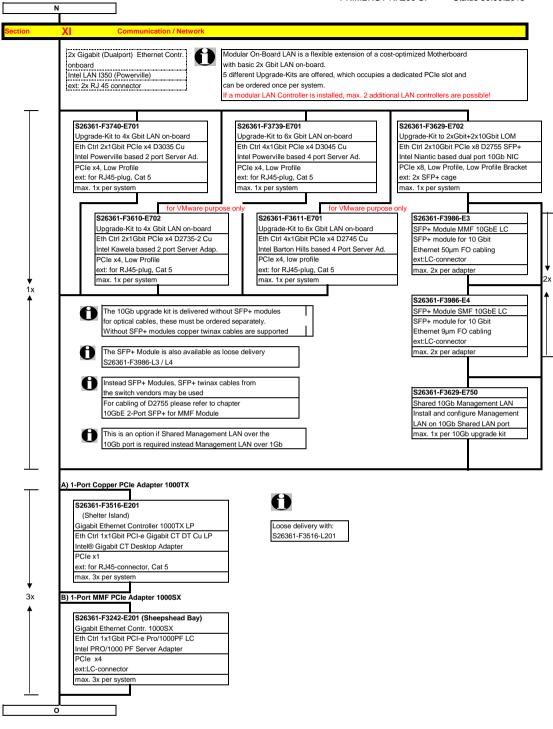
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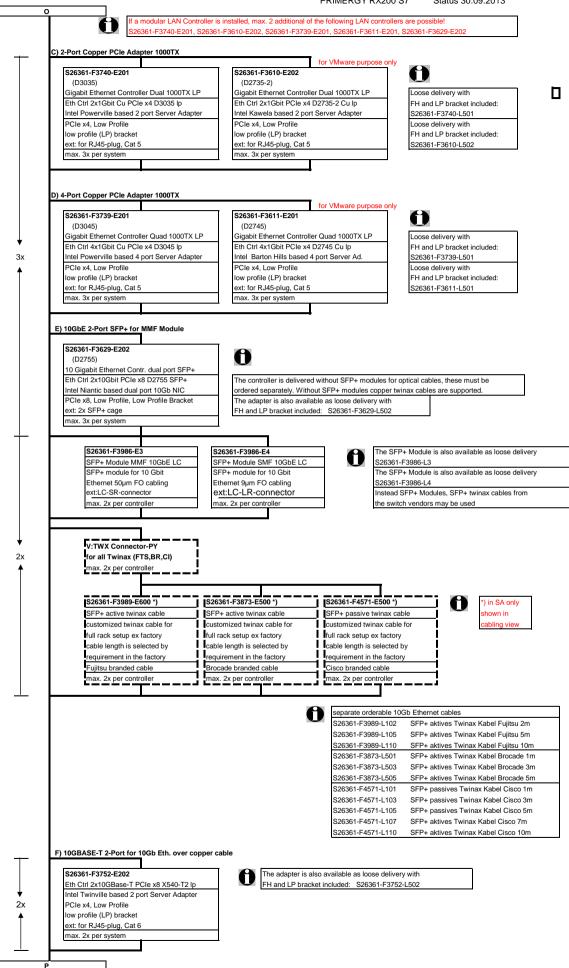


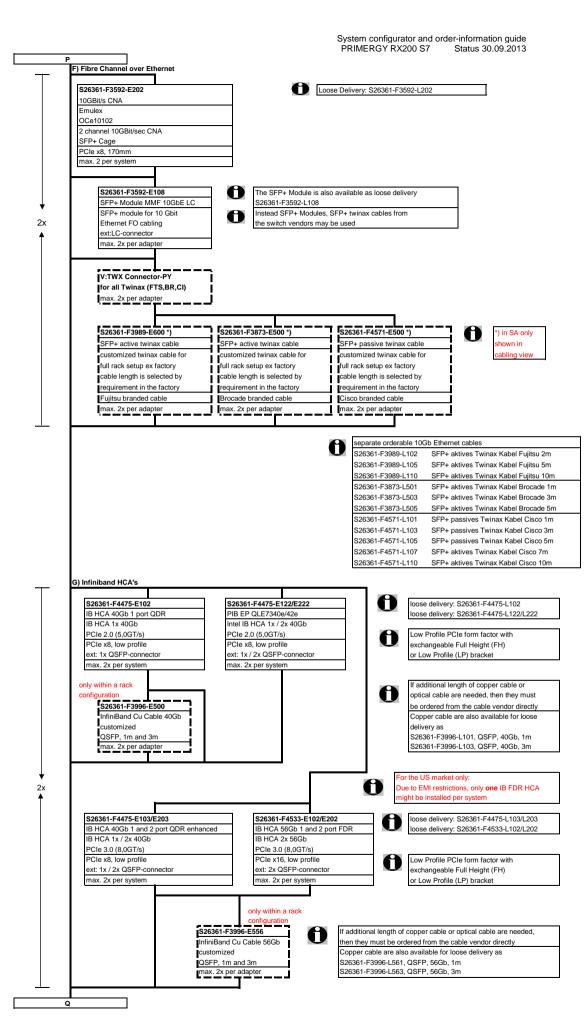


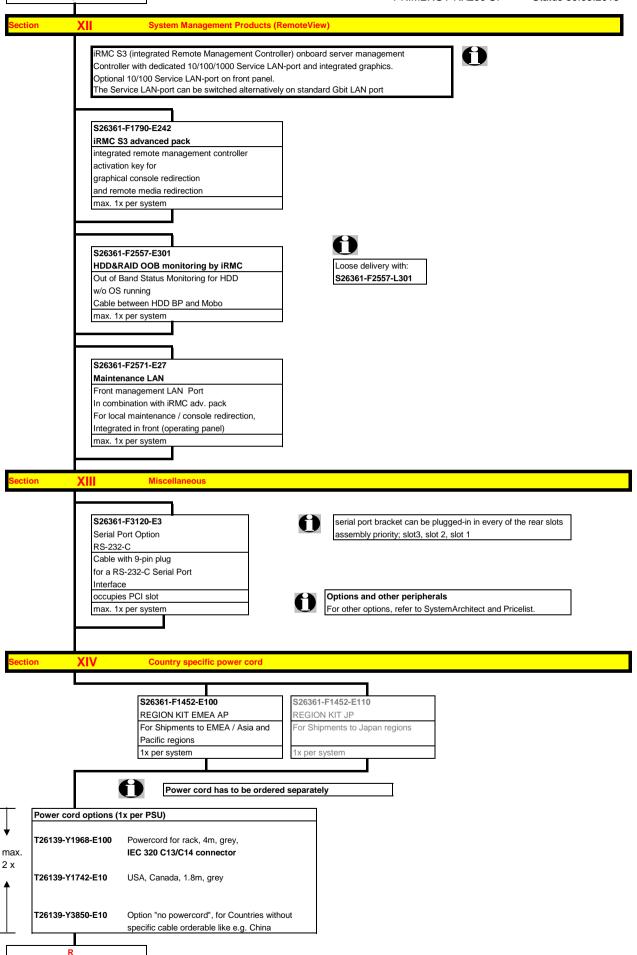












	R	PRIMERGY RX200 S7 Status 30.
Section	XVI CCC exclusions	
	S26361-F3301-E120 CCC Certification for China Limits configuration in accordance with CCC exclusions max. 1x per system The following order components out of the specific section are NOT allowed together with CCC Certification for China	
	ODD (only V101) DVD-RW supermulti slim SATA Blu-ray Triple Writer slim SATA	S26361-F3269-E2 S26361-F3641-E2
	Raid Controller external RAID Ctrl SAS 6G 8port external SAS Controller 6Gb/s 8 port LP	S26361-F3593-E201 S26361-F3628-E201
	Fibre Cannel Controller 8GBit/s FC Controller Qlogic 8GBit/s FC Controller Emulex	S26361-F3631-E201 S26361-F3961-E202
	Comm., Network Upgrade-Kit to 2xGbit+2x10Gbit LAN on-board SFP+ Module MMF 10GbE LC	S26361-F3629-E702 S26361-F3986-E3
	Shared 10Gb Management LAN Gigabit Ethernet Controller 1000TX LP Gigabit Ethernet Contr. 1000SX 10 Gigabit Ethernet Contr. dual port SFP+	S26361-F3629-E750 S26361-F3516-E201 S26361-F3242-E201 S26361-F3629-E202
	10GBit/s CNA	S26361-F3592-E202

End PRIMERGY RX200 S7

Change Report

Date	Order number	Changes
0040 00 40		Osures 2 1/2 and susile to with TEM and EDU
2013-06-10	S26361-F3669-E3	Cougar 3 V3 not available with TFM and FBU
2013-05-29	S26361-F3610-E202	D2735 for VMware purpose added
2013-05-23	S26361-F3713-E203	RAID Ctrl SAS 6G 8Port ex 1GB LSI V3
2013-05-16		HDD & SSD description text updated
2013-03-25	S26361-F3669-E661/L661	RAID advanced SW options added - for RAID Ctrl SAS 6G 8port external
2013-03-25	S26361-F3669-E660/L660	RAID advanced SW option added - for RAID Ctrl SAS 6G 1GB (D3116C)
2013-03-25	S26361-F3669-E3	RAID Ctrl SAS 6G 1GB (D3116C) added
2013-02-13	S26361-F3694-E3	comment (as soon as available) removed
2013-02-04	S26361-F4995-*	added preliminary LPe1600x
2013-01-29	S26361-F2735-E145	Add RMK-F1 Standard , tab basic units
2013-01-08	S26361-F5247-E*	New 2.5" SAS HDD order number (135W CPU supported, mix with BC-SATA suported, sucessor for * F5227*)
2012-11-27	S26361-F5228-E500/-E100	2.5" BC-SAS 500GB/1TB added
2012-11-14	000004 50000 1400/1440	200GB SLC SSD removed as EOL
2012-11-14	S26361-F3669-L100/-L110 S26361-F3669-E2 S26361-	know available
	F3669-E100 S26361-F3669-	
	E125	
2012-11-14	-	added (S26361-F3669-E1 removed)
	S26361-F3713-E201 S26361	
2012-11-14	F3669-E155	know available including FBU
2012-10-19		comment added: Optional Front-VGA S26361-F2571-E26 cannot be ordered if NVS300 is required.
2012-10-14	S26361-F3301-E120	Added CCC exclusions
2012-10-10	S26361-F3749-E201	Added USB 3.0 Adapter
2012-10-02	S26361-F4522-E121	now released
2012-10-02	S26361-F4522-E781	now released
2012-09-28	S26361-F4541-E200	SSD no longer available
	S26361-F3739-E201/701	
	S26361-F3740-E201/701	
2012-09-28	S26361-F3752-E202	Added New dual/quad 1Gb controller and 10Gb BASE-T controller
2012-09-26		LAN controller 3x instead of 2x per system (typo corrected)
2012-08-29	S26361-F4522-E781	as soon as released
2012-08-24	S26361-F3641-E2	comment (as soon as available) removed,
2012-08-24	S26361-F3698-E516/-E517	comment (as soon as available) removed, extended delivery time
2012-08-20	S26341-F103-L127	comment (as soon as released) removed
2012-08-20	S26341-F103-L126	comment (as soon as released) removed
2012-08-17	S26361-F4522-E641	removed, PCIe-SSD 640GB MLC
2012-08-17	S26361-F4522-E321	removed, PCIe-SSD 320GB MLC
2012-07-30	S26361-F2735-L176	Add RMK-F1 LV w/o. CMA adapter (short rail 731mm)
2012-07-25	S26361-F4581-Exxx	Add SSD SAS MLC
2012-07-25	S26361-F5225-Exxx	Add SSD SATA MLC
2012-07-13	S26361-F5227-E1*	New order for 2.5" 10K SAS HDD supporting mix with 2.5" BC-SATA HDD
2012-06-28		Restriction of TFM / FBU for F3669-E1
2012-05-16		Sheet CCC exclusions added
2012-04-20	S26361-F3669-E125	F3669: FBU cable lenghts changed from 55 to 25
2012-04-20	S26361-F3713-E201	new ext. SAS RAID controller added
2012-04-20		Memory voltage / frequency spreadsheet, 3DPC at 1.5V only
2012-03-30	S26361-F2735-L7	optional lateral cable mangement added for loose delivery for asymetrical racks
2012-02-29		First Release
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